

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YONGKOO LEE	07/29/2016
YOUNJUNG KIM	07/29/2016
HYUNGMIN KIM	07/29/2016
HYUNGMIN LEE	07/29/2016
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU, GYEONGGI-DO
City:	SUWON-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29574686
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	202-429-0020
Email:	pto@nsiplaw.com
Correspondent Name:	NSIP LAW
Address Line 1:	P.O. BOX 65745
Address Line 4:	WASHINGTON, D.C. 20035
ATTORNEY DOCKET NUMBER:	D91111.0365
NAME OF SUBMITTER:	CHARLES Y. PARK
SIGNATURE:	/Charles Y. Park/
DATE SIGNED:	08/18/2016
Total Attachments: 2	
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As a below-named inventor, I hereby declare that this declaration is directed to the application attached hereto, or to United States Application Number or PCT International Application Number 29/574,686
filed on: August 18, 2016 (if applicable), entitled:

The above-identified application was made or authorized to be made by me.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the above-identified application, including the claims.

I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information that became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

For valuable consideration, I, as a below-named assignor, hereby assign to:

Samsung Electronics Co., Ltd.
129, Samsung-ro, Yeongtong-gu
Suwon-si, Gyeonggi-do 16677
Republic of Korea

and its successors and assigns (collectively hereinafter called "the Assignees"), the entire right, title, and interest throughout the world in the inventions and improvements that are the subject of the application identified in the above declaration, which is United States Application Number or PCT International Application Number

29/574,686 filed on **August 18, 2016**

I authorize and request the attorneys appointed in the above-identified application to hereafter complete this Assignment by inserting above the application number and the filing date of the above-identified application when known, and to correct any typographical errors that may be discovered in this Assignment.

This Assignment includes the above-identified application, any and all United States and foreign patents, utility models, and design registrations granted for any of the inventions and improvements that are the subject of the above-identified application, and the right to claim priority based on the filing date of the above-identified application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

Inventor's Legal Name	Yongkoo LEE		
Inventor's Signature		Date	July 29th 2016
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	106-2004, Mullae XI Apt., 12, Daegsan-ro 4-gil, Yeongdeungpo-gu, Seoul, Republic of Korea		

Inventor's Legal Name	Younjung KIM		
Inventor's Signature		Date	July, 24th, 2016
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	109-206, Sangnoksu Apt., 15, Gwangpyeong-ro 10-gil, Gangnam-gu, Seoul, Republic of Korea		

Inventor's Legal Name	Hyungmin KIM		
Inventor's Signature		Date	July 29th, 2016
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	101-804, Hanjin Town Apt., 310, Teukseom-ro, Seongdong-gu, Seoul, Republic of Korea		

Inventor's Legal Name	Hyungmin LEE		
Inventor's Signature		Date	July, 29th, 2016
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	7-719, Shindonga Apt., 130, Saimdang-ro, Seccho-gu, Seoul, Republic of Korea		